

SUBJECT: Chip Bead Array, EXC228BB/BA Series

BULLETIN #: ECN.PG42.05.16.05-1

Date: May 16, 2005

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EFFECTIVE DATE: July 1, 2005 (Running Change)

LAST TIME BUY: N/A

LAST TIME SHIPMENT: N/A

SUGGESTED REPLACEMENT: N/A

DISCONTINUATION DETAILS: Removal of the antioxidant package on 2 of our Chip Bead Arrays products: EXC-28BB and BA series. Our enhanced plating method will be applied minimizing oxidation. This change will help make the product become more tolerant to humidity and temperature.

OTHER DETAILS:

Current	New
<ul style="list-style-type: none">1) With the antioxidant packaging2) Expiration date: 6 month after manufacturing3) Parts need to be used within 168 hrs of first opening the pack.	<ul style="list-style-type: none">1) Without the antioxidant packaging2) Exp. date is six month after our delivery. <p>•Note: Material, electrical and mechanical specification will remain unchanged.</p>
	